



General Description

The MAX9705 3rd-generation, ultra-low EMI, mono, Class D audio power amplifier provides Class AB performance with Class D efficiency. The MAX9705 delivers 2.3W into a 4Ω load and offers efficiencies above 85%. Active emissions limiting (AEL) circuitry greatly reduces EMI by actively controlling the output FET gate transitions under all possible transient output-voltage conditions. AEL prevents high-frequency emissions resulting from conventional Class D free-wheeling behavior in the presence of an inductive load. Zero dead time (ZDT) technology maintains state-of-the-art efficiency and THD+N performance by allowing the output FETs to switch simultaneously without cross-conduction. A patented spreadspectrum modulation scheme eliminates the need for output filtering found in traditional Class D devices. These design concepts reduce an application's component count and extend battery life.

The MAX9705 offers two modulation schemes: a fixedfrequency (FFM) mode and a spread-spectrum (SSM) mode that further reduces EMI-radiated emissions due to the modulation frequency. The MAX9705 oscillator can be synchronized to an external clock through the SYNC input, allowing the switching frequency to be externally defined. The SYNC input also allows multiple MAX9705s to be cascaded and frequency locked, minimizing interference due to clock intermodulation. The device utilizes a fully differential architecture, a full-bridged output, and comprehensive click-and-pop suppression. The gain of the MAX9705 is set internally (MAX9705A: 6dB, MAX9705B: 12dB, MAX9705C: 15.6dB, MAX9705D: 20dB), further reducing external component count.

The MAX9705 is available in 10-pin TDFN (3mm x 3mm x 0.8mm), 10-pin μ MAX®, and 12-bump UCSPTM (1.5mm x 2mm x 0.6mm) packages. The MAX9705 is specified over the extended -40°C to +85°C temperature range.

Applications

Cellular Phones **PDAs**

MP3 Players Portable Audio

Selector Guide appears at end of data sheet.

µMAX is a registered trademark and UCSP is a trademark of Maxim Integrated Products, Inc.

Features

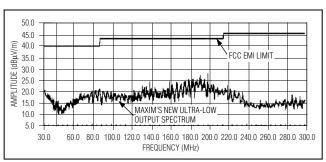
- ♦ Filterless Amplifier Passes FCC-Radiated **Emissions Standards with 24in of Cable**
- ♦ Unique Spread-Spectrum Mode and Active **Emissions Limiting (AEL) Achieves Better than** 20dB Margin Under FCC Limits
- **♦ Zero Dead Time (ZDT) H-Bridge Maintains State**of-the-Art Efficiency and THD+N
- ♦ Simple Master-Slave Setup for Stereo Operation
- ◆ Up to 90% Efficiency
- ♦ 2.3W into 4Ω (1% THD+N)
- ♦ Low 0.02% THD+N (Pout = 1W, VDD = 5.0V)
- ♦ High PSRR (75dB at 217Hz)
- ♦ Integrated Click-and-Pop Suppression
- ♦ Low Quiescent Current (5.4mA)
- ♦ Low-Power Shutdown Mode (0.3µA)
- ♦ Short-Circuit and Thermal-Overload Protection
- ♦ Available in Thermally Efficient, Space-Saving **Packages**
 - 10-Pin TDFN (3mm x 3mm x 0.8mm)
 - 10-Pin µMAX
 - 12-Bump UCSP (1.5mm x 2mm x 0.6mm)
- ♦ Pin-for-Pin Compatible with the MAX9700 and MAX9712

Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX9705AETB+T	-40°C to +85°C	10 TDFN-10	ACY
MAX9705AEUB+	-40°C to +85°C	10 μMAX	
MAX9705AEBC+T	-40°C to +85°C	12 UCSP-12	ACH
MAX9705BETB+T	-40°C to +85°C	10 TDFN-10	ACX
MAX9705BEUB+	-40°C to +85°C	10 μMAX	_
MAX9705BEBC+T	-40°C to +85°C	12 UCSP-12	ACG

Ordering Information continued at end of data sheet.

EMI Spectrum Diagram



MIXIM

Maxim Integrated Products 1

⁺Denotes lead-free package.

ABSOLUTE MAXIMUM RATINGS

V _{DD} to GND	
GND to PGND	
PV _{DD} to V _{DD}	
All Other Pins to GND0	$.3V \text{ to } (V_{DD} + 0.3V)$
Continuous Current Into/Out of PVDD/PGND/	
Continuous Input Current (all other pins)	±20mA
Duration of OUT_ Short Circuit to GND or PV	DDContinuous
Duration of Short Circuit Between OUT+ and 0	OUTContinuous

Continuous Power Dissipation ($T_A = +70$ °C)
10-Pin TDFN (derate 24.4mW/°C above +70°C)1951.2mW
10-Pin μMAX (derate 5.6mW/°C above +70°C)444.4mW
12-Bump UCSP (derate 6.1mW/°C above +70°C)484mW
Junction Temperature+150°C
Operating Temperature Range40°C to +85°C
Storage Temperature Range65°C to +150°C
Lead Temperature (soldering, 10s)+300°C
Bump Temperature (soldering)
Reflow+235°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = PV_{DD} = \overline{SHDN} = 3.3V, GND = PGND = 0V, SYNC = GND (FFM), R_L = \infty, R_L connected between OUT+ and OUT-, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)$

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
GENERAL	1						•
Supply Voltage Range	V_{DD}	Inferred from PSRR test		2.5		5.5	V
Quiescent Current	I _{DD}				5.4	7	mA
Shutdown Current	ISHDN				0.3	10	μΑ
Turn-On Time	ton				30		ms
Input Resistance	R _{IN}	T _A = +25°C		12	20		kΩ
		N	//AX9705A	0.88	1.0	1.12	V mA μA ms kΩ V V/V MV dB dB dB mW
Input Bias Voltage	V _{BIAS}	Leither innuit	//AX9705B	0.73	0.83	0.93	\/
Input bias voltage	VBIAS	Littlet illbat	//AX9705C	0.61	0.71	0.81	V V/V mV
		N	//AX9705D	0.48	0.56	0.64	
		MAX9705A		1.9	2.0	2.1	V mA μA ms kΩ V V/V MV dB dB dB
Voltage Gain	Δ	MAX9705B		3.8	4.0	4.2	
	Av	MAX9705C		5.7	6.0	6.3	
		MAX9705D		9.5	10	10.5	
Output Offset Voltage	Vos	$T_A = +25^{\circ}C$			±10	±69	mV
Common-Mode Rejection Ratio	CMRR	f _{IN} = 1kHz, input referre	d		56		dB
		$V_{DD} = 2.5V \text{ to } 5.5V, T_A =$	= +25°C	50	75		
Power-Supply Rejection Ratio (Note 3)	PSRR	0001/	f _{RIPPLE} = 217Hz		75		dB
(Note 3)		200mV _{P-P} ripple	f _{RIPPLE} = 20kHz		60		1 1
Outrot Brown	D	THD+N = 1%,	$R_L = 8\Omega$		600		mW
Output Power	Pout	$f_{IN} = 1kHz$	$R_L = 4\Omega$		950		
Total Harmonic Distortion	TUD N	f _{IN} = 1kHz, either FFM o	$R_L = 8\Omega,$ POUT = 450mW		0.02		0/
Plus Noise	THD+N	SSM	$R_L = 4\Omega,$ $P_{OUT} = 375$ mW		0.025		%
Click/Don Lovel	Von	Peak voltage,	Into shutdown		-68		٩D
Click/Pop Level	K _{CP}	A-weighted (Notes 3, 4)	Out of shutdown		-60.5		UB

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = PV_{DD} = \overline{SHDN} = 3.3V$, GND = PGND = 0V, SYNC = GND (FFM), R_L = ∞ , R_L connected between OUT+ and OUT-, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Output Slew Rate	SR					176		V/µs
Rise/Fall Time	trise, trall	10% to 90%				15		ns
			BW = 22Hz	FFM		91		
Signal-to-Noise Ratio	SNR	Vout = 2VRMS	to 22kHz	SSM		89		dB
Signal-to-Noise Hatio	SIVIT	VUUI - ZVRIVIS	A-weighted	FFM		93		ub
			A-weighted	SSM		91		
		SYNC = GND			980	1100	1220	
Oscillator Frequency	food	SYNC = float 1250 1450 16				1650	kHz	
Oscillator Frequency	fosc	CVNC - Vpp (CCN	1 mada)			1220	1220	NI IZ
		$SYNC = V_{DD} (SSM mode)$			±120			
SYNC Frequency Lock Range					800		2000	kHz
Efficiency	η	$P_{OUT} = 800$ mW, $f_{IN} = 1$ kHz, $R_L = 8\Omega$				89		%
DIGITAL INPUTS (SHDN, SYNC)								
Input Throsholds		VIH		2			V	
Input Thresholds		VIL					89 93 91 1100 1220 1450 1650 1220 ±120 2000	V
SHDN Input Leakage Current						0.1	±10	μΑ
SYNC Input Current		(Note 5)				-1.25	±10	μΑ

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = PV_{DD} = \overline{SHDN} = 5V$, GND = PGND = 0V, SYNC = GND (FFM), R_L = ∞ , R_L connected between OUT+ and OUT-, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

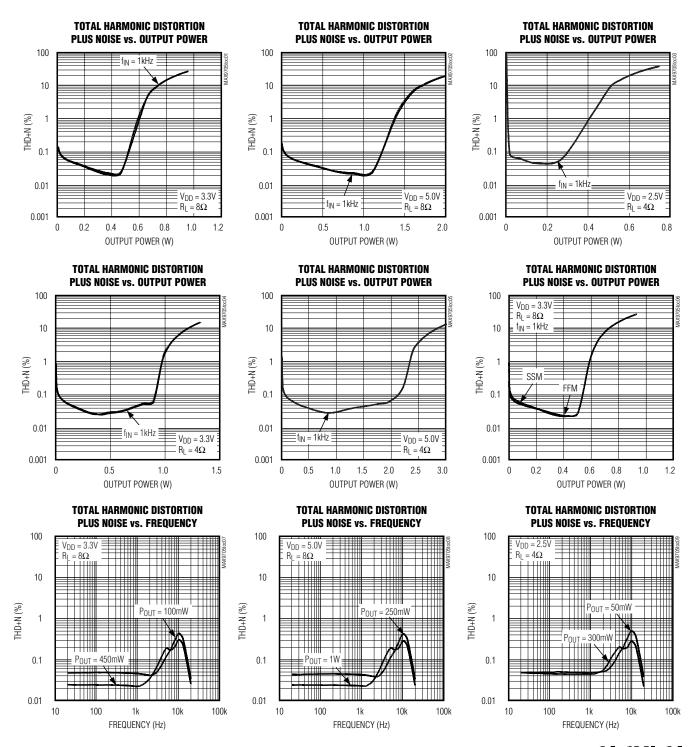
PARAMETER	SYMBOL		CC	ONDITIONS		MIN	TYP	MAX	UNITS		
Quiescent Current	I _{DD}						7		mA		
Shutdown Current	ISHDN						0.55		μΑ		
Power-Supply Rejection Ratio	PSRR	200mV _{P-P} ri	nnlo	f = 217Hz			75		4D		
Tower-Supply Nejection Hallo	1 31111	20011179-911	ppie	f = 20kHz			60		dB		
				THE ALL		$R_L = 16\Omega$			750		
Output Power	Pout	THD+N = 1 f = 1kHz	%,	$R_L = 8\Omega$			1400		mW		
				$R_L = 4\Omega$			2300				
Total Harmonic Distortion	THD+N	f = 1kHz, eit	her	$R_L = 8\Omega$, F	$P_{OUT} = 1.0W$		0.02		0/		
Plus Noise	IUD+N	FFM or SSM	1	$R_L = 4\Omega$, P	$P_{OUT} = 1.75W$		0.05		/0		
			BW :	= 22Hz to	FFM		94				
Signal-to-Noise Ratio	CND	Vout =	22kH	Ηz	SSM		91				
	SNR	3V _{RMS}	Λ	a i sula ta al	FFM		97		uB		
			A-W6	eighted	SSM		93				

- Note 1: All devices are 100% production tested at +25°C. All temperature limits are guaranteed by design.
- Note 2: Testing performed with a resistive load in series with an inductor to simulate an actual speaker load. For $R_L = 4\Omega$, $L = 33\mu H$. For $R_L = 8\Omega$, $L = 68\mu H$. For $R_L = 16\Omega$, $L = 136\mu H$.
- Note 3: Inputs AC-coupled to GND.
- Note 4: Testing performed with 8Ω resistive load in series with 68μH inductive load connected across BTL output. Mode transitions are controlled by SHDN pin. K_{CP} level is calculated as 20 x log[(peak voltage under normal operation at rated power level)/(peak voltage during mode transition, no input signal)]. Units are expressed in dB.
- **Note 5:** SYNC has a $1M\Omega$ resistor to $V_{REF} = 1.25V$.



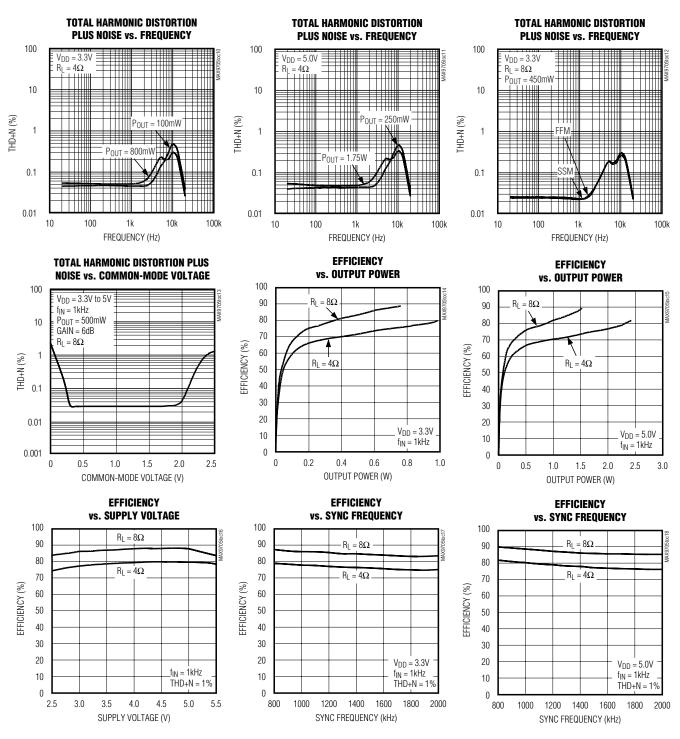
Typical Operating Characteristics

(V_{DD} = 3.3V, SYNC = V_{DD} (SSM), differential input, T_A = +25°C, unless otherwise noted.)



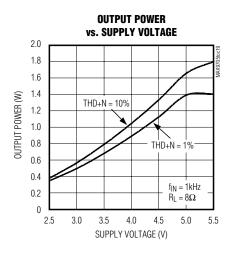
Typical Operating Characteristics (continued)

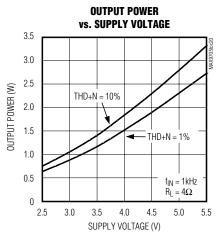
 $(V_{DD} = 3.3V, SYNC = V_{DD} (SSM), differential input, T_A = +25°C, unless otherwise noted.)$

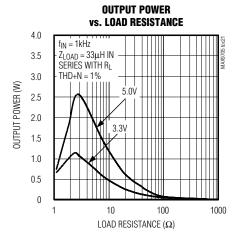


Typical Operating Characteristics (continued)

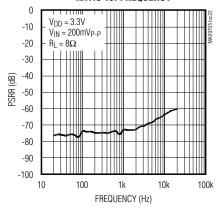
 $(V_{DD} = 3.3V, SYNC = V_{DD} (SSM), differential input, T_A = +25°C, unless otherwise noted.)$



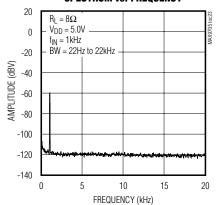




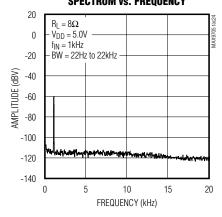
POWER-SUPPLY REJECTION RATIO vs. FREQUENCY



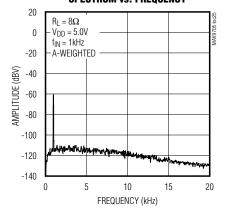
FIXED-FREQUENCY-MODE OUTPUT SPECTRUM vs. FREQUENCY



SPREAD-SPECTRUM-MODE OUTPUT SPECTRUM vs. FREQUENCY

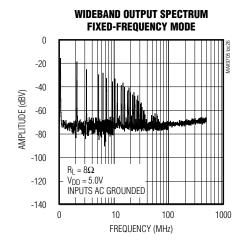


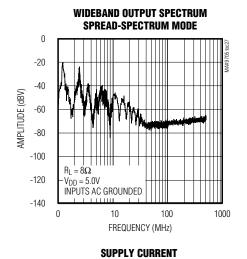
SPREAD-SPECTRUM-MODE OUTPUT SPECTRUM vs. FREQUENCY

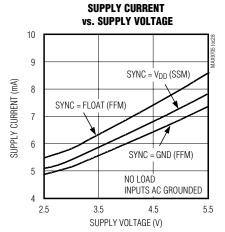


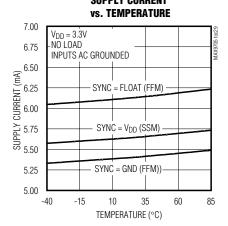
Typical Operating Characteristics (continued)

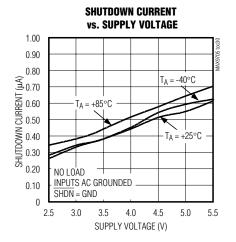
 $(V_{DD} = 3.3V, SYNC = V_{DD} (SSM), differential input, T_A = +25°C, unless otherwise noted.)$

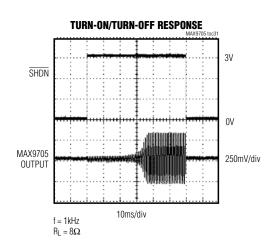




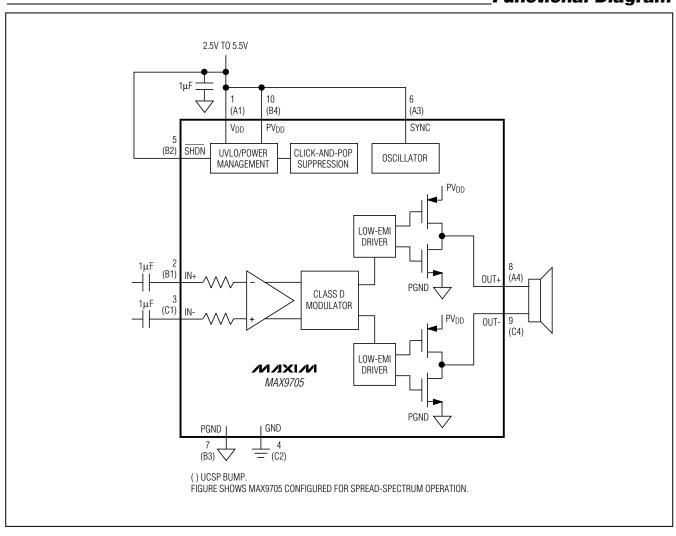








Functional Diagram



Pin Description

PIN	BUMP	NAME	FUNCTION		
TDFN/µMAX	UCSP	NAME	FONCTION		
1	A1	V _{DD}	Analog Power Supply		
2	B1	IN+	Noninverting Audio Input		
3	C1	IN-	Inverting Audio Input		
4	C2	GND	Analog Ground		
5	B2	SHDN	Active-Low Shutdown Input. Connect to VDD for normal operation.		
6	А3	SYNC	Frequency Select and External Clock Input. SYNC = GND: Fixed-frequency mode with f _S = 1100kHz. SYNC = Float: Fixed-frequency mode with f _S = 1450kHz. SYNC = V _{DD} : Spread-spectrum mode with f _S = 1220kHz ±120kHz. SYNC = Clocked: Fixed-frequency mode with f _S = external clock frequency.		
7	В3	PGND	Power Ground		
8	A4	OUT+	Amplifier-Output Positive Phase		
9	C4	OUT-	Amplifier-Output Negative Phase		
10	B4	PV _{DD}	H-Bridge Power Supply		

Detailed Description

The MAX9705 ultra-low-EMI, filterless, Class D audio power amplifier features several improvements to switch-mode amplifier technology. The MAX9705 features output driver active emissions limiting circuitry to reduce EMI. Zero dead time technology maintains state-of-the-art efficiency and THD+N performance by allowing the output FETs to switch simultaneously without cross-conduction. A unique filterless modulation scheme, synchronizable switching frequency, and spread-spectrum mode create a compact, flexible, low-noise, efficient audio power amplifier while occupying minimal board space. The differential input architecture reduces common-mode noise pickup with or without the use of input-coupling capacitors. The MAX9705 can also be configured as a single-ended input amplifier without performance degradation.

Thermal-overload and short-circuit protection prevent the MAX9705 from being damaged during a fault condition. The amplifier is disabled if the die temperature reaches +150°C. The die must cool by 10°C before normal operation can continue. The output of the MAX9705 shuts down if the output current reaches approximately 2A. Each output FET has its own short-circuit protection. This protection scheme allows the amplifier to survive shorts to either supply rail. After a thermal overload or short circuit, the device remains disabled for a minimum of 50µs before attempting to return to normal operation. The amplifier will shut down immediately and wait another 50µs before turning on if the fault condition is still present. This operation will cause the output to pulse during a persistent fault.

Comparators monitor the MAX9705 inputs and compare the complementary input voltages to the sawtooth waveform. The comparators trip when the input magnitude of the sawtooth exceeds their corresponding input voltage. Both comparators reset at a fixed time after the rising edge of the second comparator trip point, generating a minimum-width pulse ton(MIN) at the output of the second comparator (Figure 1). As the input voltage increases or decreases, the duration of the pulse at one output increases (the first comparator to trip), while the other output pulse duration remains at ton(MIN). This causes the net voltage across the speaker (Vout+ Vout-) to change.

Operating Modes

Fixed-Frequency Modulation (FFM) Mode

The MAX9705 features two FFM modes. The FFM modes are selected by setting SYNC = GND for a 1.1MHz switching frequency, and SYNC = FLOAT for a 1.45MHz switching frequency. In FFM mode, the frequency spectrum of the Class D output consists of the fundamental switching frequency and its associated harmonics (see the Wideband FFT graph in the *Typical Operating Characteristics*). The MAX9705 allows the switching frequency to be changed by +32%, should the frequency of one or more of the harmonics fall in a sensitive band. This can be done at any time and does not affect audio reproduction.

Spread-Spectrum Modulation (SSM) Mode

The MAX9705 features a unique, patented spread-spectrum mode that flattens the wideband spectral components,

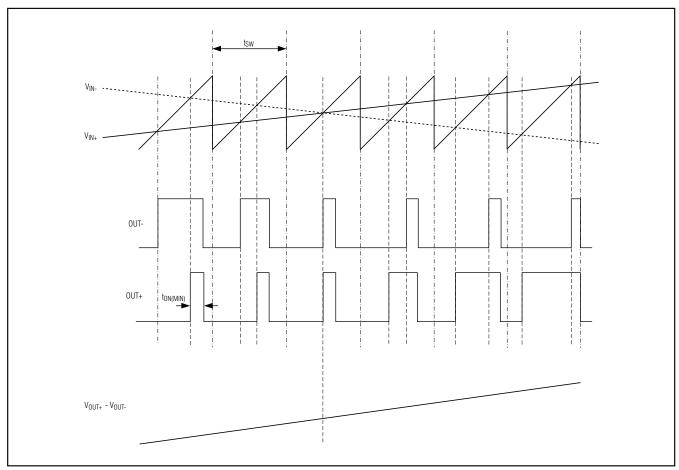


Figure 1. MAX9705 Outputs with an Input Signal Applied

Table 1. Operating Modes

SYNC INPUT	MODE
GND	FFM with $f_S = 1100kHz$
FLOAT	FFM with $f_S = 1450kHz$
V _{DD}	SSM with $f_S = 1220kHz \pm 120kHz$
Clocked	FFM with fs = external clock frequency

improving EMI emissions by 5dB. Proprietary techniques ensure that the cycle-to-cycle variation of the switching period does not degrade audio reproduction or efficiency (see the *Typical Operating Characteristics*). Select SSM mode by setting SYNC = V_{DD}. In SSM mode, the switching frequency varies randomly by ±120kHz around the center frequency (1.22MHz). The modulation scheme remains the same, but the period of the sawtooth waveform changes from cycle to cycle (Figure 2). Instead of a large amount of spectral energy present at multiples of

the switching frequency, the energy is now spread over a bandwidth that increases with frequency. Above a few megahertz, the wideband spectrum looks like white noise for EMI purposes (see the *EMI Spectrum Diagram*).

External Clock Mode

The SYNC input allows the MAX9705 to be synchronized to a system clock moving the spectral components of the switching harmonics to insensitive frequency bands. Applying an external TTL clock of 800kHz to 2MHz to SYNC synchronizes the switching frequency of the MAX9705. The period of the SYNC clock can be randomized, enabling the MAX9705 to be synchronized to another MAX9705 operating in SSM mode.

Filterless Modulation/Common-Mode Idle

The MAX9705 uses Maxim's unique, patented modulation scheme that eliminates the LC filter required by traditional Class D amplifiers, improving efficiency, reducing component count, and conserving board

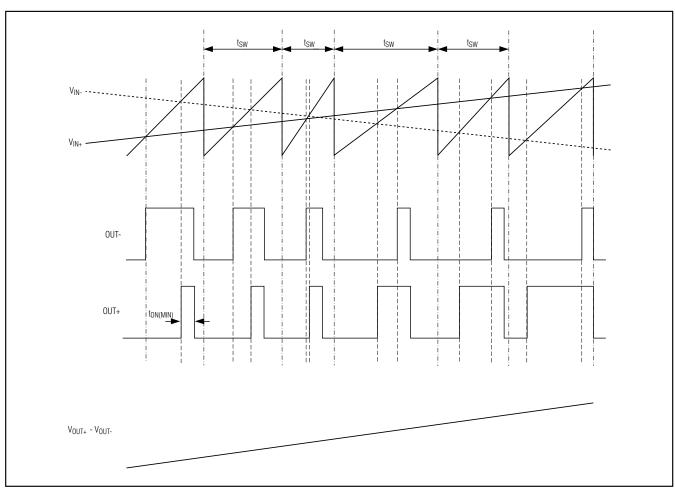


Figure 2. MAX9705 Output with an Input Signal Applied (SSM Mode)

space and system cost. Conventional Class D amplifiers output a 50% duty cycle square wave when no signal is present. With no filter, the square wave appears across the load as a DC voltage, resulting in a finite load current, increasing power consumption. When no signal is present at the input of the MAX9705, the outputs switch as shown in Figure 3. Because the MAX9705 drives the speaker differentially, the two outputs cancel each other, resulting in no net idle-mode voltage across the speaker, minimizing power consumption.

Efficiency

Efficiency of a Class D amplifier is attributed to the region of operation of the output stage transistors. In a Class D amplifier, the output transistors act as current-steering switches and consume negligible additional

power. Any power loss associated with the Class D output stage is mostly due to the I²R loss of the MOSFET on-resistance and quiescent-current overhead.

The theoretical best efficiency of a linear amplifier is 78%; however, that efficiency is only exhibited at peak output powers. Under normal operating levels (typical music reproduction levels), efficiency falls below 30%, whereas the MAX9705 still exhibits >70% efficiencies under the same conditions (Figure 4).

Shutdown

The MAX9705 has a shutdown mode that reduces power consumption and extends battery life. Driving SHDN low places the MAX9705 in a low-power (0.3µA) shutdown mode. Connect SHDN to VDD for normal operation.

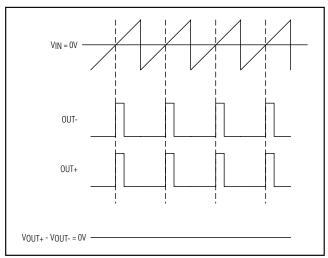


Figure 3. MAX9705 Outputs with No Input Signal

Click-and-Pop Suppression

The MAX9705 features comprehensive click-and-pop suppression that eliminates audible transients on start-up and shutdown. While in shutdown, the H-bridge is in a high-impedance state. During startup or power-up, the input amplifiers are muted and an internal loop sets the modulator bias voltages to the correct levels, preventing clicks and pops when the H-bridge is subsequently enabled. For 30ms following startup, a soft-start function gradually unmutes the input amplifiers.

Applications Information Filterless Operation

Traditional Class D amplifiers require an output filter to recover the audio signal from the amplifier's output. The filters add cost, increase the solution size of the amplifier, and can decrease efficiency and THD+N performance. The traditional PWM scheme uses large differential output swings (2 x V_{DD} peak-to-peak) and causes large ripple currents. Any parasitic resistance in the filter components results in a loss of power, lowering the efficiency.

The MAX9705 does not require an output filter. The device relies on the inherent inductance of the speaker coil and the natural filtering of both the speaker and the human ear to recover the audio component of the square-wave output. Eliminating the output filter results in a smaller, less costly, more efficient solution.

Because the frequency of the MAX9705 output is well beyond the bandwidth of most speakers, voice coil movement due to the square-wave frequency is very small. Although this movement is small, a speaker not

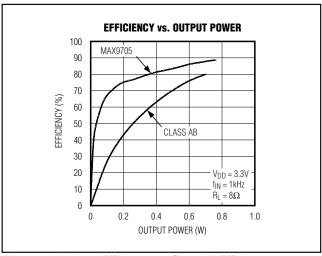


Figure 4. MAX9705 Efficiency vs. Class AB Efficiency

designed to handle the additional power can be damaged. For optimum results, use a speaker with a series inductance >10 μ H. Typical 8 Ω speakers exhibit series inductances in the 20 μ H to 100 μ H range.

Power-Conversion Efficiency

Unlike a class AB amplifier, the output offset voltage of a Class D amplifier does not noticeably increase quiescent-current draw when a load is applied. This is due to the power conversion of the Class D amplifier. For example, an 8mV DC offset across an 8Ω load results in 1mA extra current consumption in a Class AB device. In the Class D case, an 8mV offset into 8Ω equates to an additional power drain of $8\mu W$. Due to the high efficiency of the Class D amplifier, this represents an additional quiescent-current draw of $8\mu W/(V_{DD}/100\eta)$, which is on the order of a few microamps.

Input Amplifier Differential Input

The MAX9705 features a differential input structure, making it compatible with many CODECs, and offering improved noise immunity over a single-ended input amplifier. In devices such as cellular phones, high-frequency signals from the RF transmitter can be picked up by the amplifier's input traces. The signals appear at the amplifier's inputs as common-mode noise. A differential input amplifier amplifies the difference of the two inputs; any signal common to both inputs is canceled.

Single-Ended Input

The MAX9705 can be configured as a single-ended input amplifier by capacitively coupling either input to GND and driving the other input (Figure 5).

Note that the single-ended voltage range of the MAX9705A is 3V_{P-P}. This limits the achievable output power for this device. Use higher gain versions (MAX9705B, MAX9705C, MAX9705D) if higher output power is desired in a single-ended application.

DC-Coupled Input

The input amplifier can accept DC-coupled inputs that are biased within the amplifier's common-mode range (see the *Typical Operating Characteristics*). DC coupling eliminates the input-coupling capacitors, reducing component count to potentially one external component (see the *System Diagram*). However, the low-frequency rejection of the capacitors is lost, allowing low-frequency signals to feed through to the load.

Component Selection Input Filter

An input capacitor, C_{IN}, in conjunction with the input resistance of the MAX9705 forms a highpass filter that removes the DC bias from an incoming signal. The AC-coupling capacitor allows the amplifier to bias the signal to an optimum DC level. Assuming zero source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN} C_{IN}}$$

Choose C_{IN} so $f_{\text{-}3dB}$ is well below the lowest frequency of interest. Setting $f_{\text{-}3dB}$ too high affects the low-frequency response of the amplifier. Use capacitors whose dielectrics have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in increased distortion at low frequencies.

Other considerations when designing the input filter include the constraints of the overall system and the actual frequency band of interest. Although high-fidelity audio calls for a flat gain response between 20Hz and 20kHz, portable voice-reproduction devices such as cellular phones and two-way radios need only concentrate on the frequency range of the spoken human voice (typically 300Hz to 3.5kHz). In addition, speakers used in portable devices typically have a poor response below 150Hz. Taking these two factors into consideration, the input filter may not need to be designed for a 20Hz to 20kHz response, saving both board space and cost due to the use of smaller capacitors.

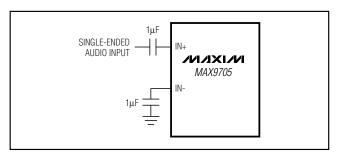


Figure 5. Single-Ended Input

Output Filter

The MAX9705 does not require an output filter. The device passes FCC emissions standards with 24in of unshielded twisted-pair speaker cables. However, an output filter can be used if a design is failing radiated emissions due to board layout or excessive cable length, or the circuit is near EMI-sensitive devices.

Supply Bypassing/Layout

Proper power-supply bypassing ensures low-distortion operation. For optimum performance, bypass VDD to GND and PVDD to PGND with separate 1µF capacitors as close to each pin as possible. A low-impedance, high-current power-supply connection to PVDD is assumed. Additional bulk capacitance should be added as required depending on the application and power-supply characteristics. GND and PGND should be star connected to system ground. Refer to the MAX9705 evaluation kit for layout guidance.

Stereo Configuration

Two MAX9705s can be configured as a stereo amplifier (Figure 6). Device U1 is the master amplifier; its unfiltered output drives the SYNC input of the slave device (U2), synchronizing the switching frequencies of the two devices. Synchronizing two MAX9705s ensures that no beat frequencies occur within the audio spectrum. This configuration works when the master device is in either FFM or SSM mode. There is excellent THD+N performance and minimal crosstalk between devices due to the SYNC connection (Figures 7 and 8). U2 locks onto only the frequency present at SYNC, not the pulse width. The internal feedback loop of device U2 ensures that the audio component of U1's output is rejected.

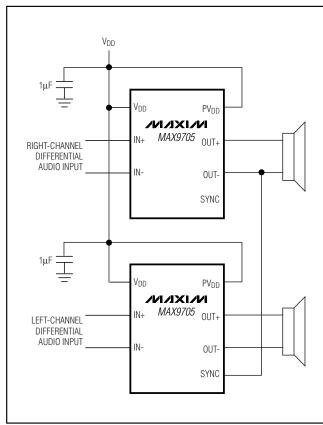


Figure 6. Master-Slave Stereo Configuration

Designing with Volume Control

The MAX9705 can easily be driven by single-ended sources (Figure 5), but extra care is needed if the source impedance "seen" by each differential input is unbalanced, such as the case in Figure 9a, where the MAX9705 is used with an audio taper potentiometer acting as a volume control. Functionally, this configuration works well, but can suffer from click-pop transients at power-up (or coming out of SHDN) depending on the volume-control setting. As shown, the click-pop performance is fine for either max or min volume, but worsens at other settings.

One solution is the configuration shown in Figure 9b. The potentiometer is connected between the differential inputs, and these "see" identical RC paths when the device powers up. The variable resistive element appears between the two inputs, meaning the setting affects both inputs the same way. The potentiometer is audio taper, as in Figure 9a. This significantly improves transient performance on power-up or release from SHDN. A similar approach can be applied when the MAX9705 is driven differentially and a volume control is required.

UCSP Applications Information

For the latest application details on UCSP construction, dimensions, tape carrier information, PC board techniques, bump-pad layout, and recommended reflow temperature profile, as well as the latest information on reliability testing results, refer to Application Note: UCSP—A Wafer-Level Chip-Scale Package available on Maxim's website at www.maxim-ic.com/ucsp.

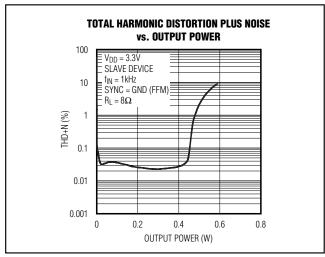


Figure 7. Master-Slave THD+N

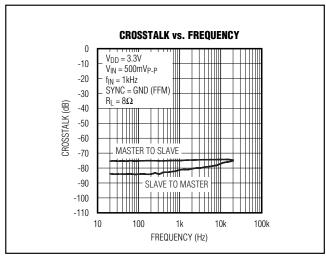


Figure 8. Master-Slave Crosstalk

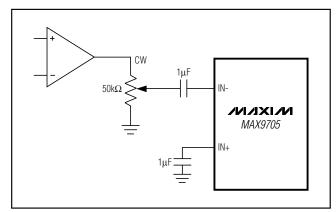


Figure 9a. Single-Ended Drive of MAX9705 Plus Volume

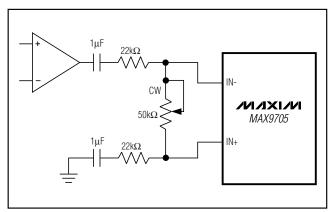


Figure 9b. Improved Single-Ended Drive of MAX9705 Plus Volume

Pin Configurations

6	V _{DD} 1 IN+ 2 IN- 3 IN- 3 SND 4 IDN 5				
	μМАХ				
 		7 6			
TOP VIEW (BUMP SIDE DOV	MAX9705	= =			
A		YNC OUT+			
В		GND PVDD			
С	IN- GND	OUT-			
UCSP					

Selector Guide

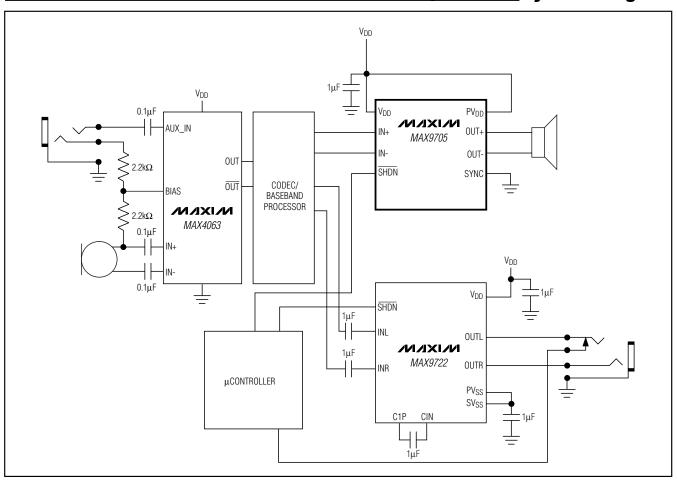
PART	PIN-PACKAGE	GAIN (dB)
MAX9705AETB+T	10 TDFN-10	6
MAX9705AEUB+	10 μMAX	6
MAX9705AEBC+T	12 UCSP-12	6
MAX9705BETB+T	10 TDFN-10	12
MAX9705BEUB+	10 μMAX	12
MAX9705BEBC+T	12 UCSP-12	12
MAX9705CETB+T	10 TDFN-10	15.6
MAX9705CEUB+	10 μMAX	15.6
MAX9705CEBC+T	12 UCSP-12	15.6
MAX9705DETB+T	10 TDFN-10	20
MAX9705DEUB+	10 μMAX	20
MAX9705DEBC+T	12 UCSP-12	20

Ordering Information (continued)

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX9705CETB+T	-40°C to +85°C	10 TDFN-10	ACZ
MAX9705CEUB+	-40°C to +85°C	10 μMAX	
MAX9705CEBC+T	-40°C to +85°C	12 UCSP-12	ACI
MAX9705DETB+T	-40°C to +85°C	10 TDFN-10	ADA
MAX9705DEUB+	-40°C to +85°C	10 μMAX	_
MAX9705DEBC+T	-40°C to +85°C	12 UCSP-12	ACJ

⁺Denotes lead-free package.

System Diagram



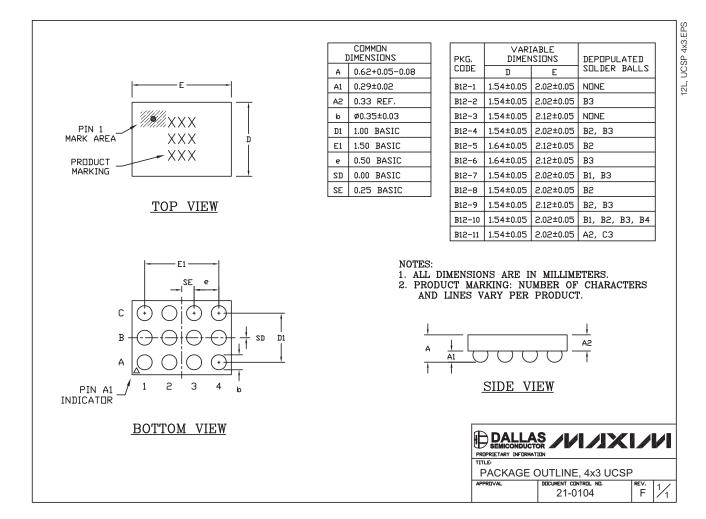
Chip Information

TRANSISTOR COUNT: 3595
PROCESS: BICMOS

MIXIN

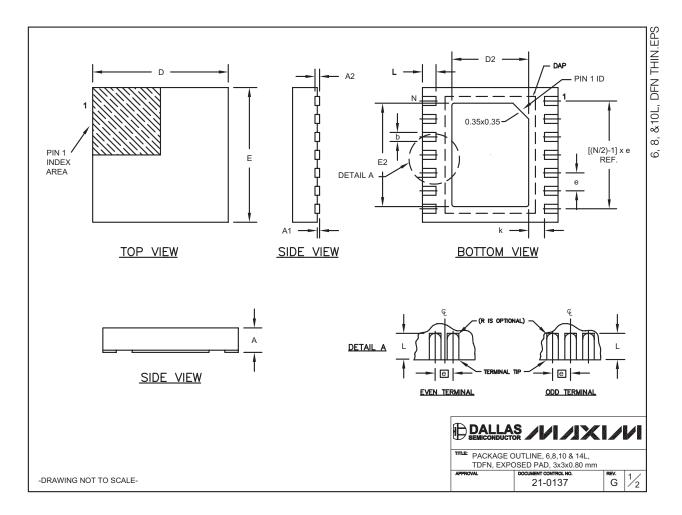
Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)

COMMON DIMENSIONS					
SYMBOL	MIN.	MAX.			
Α	0.70	0.80			
D	2.90	3.10			
E	2.90	3.10			
A1	0.00	0.05			
L	0.20 0.40				
k	0.25 MIN.				
A2	0.20 REF.				

PACKAGE VARIATIONS								
PKG. CODE	N	D2	E2	е	JEDEC SPEC	b	[(N/2)-1] x e	DOWNBONDS ALLOWED
T633-1	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	NO
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	NO
T833-1	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	NO
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	NO
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	YES
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF	NO
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	YES
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	NO

- 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
 2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
 3. WARPAGE SHALL NOT EXCEED 0.10 mm.
 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS

- SPECIAL CHARACTERISTIC(S).
- 5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.

 6. "N" IS THE TOTAL NUMBER OF LEADS.

 7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.



PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

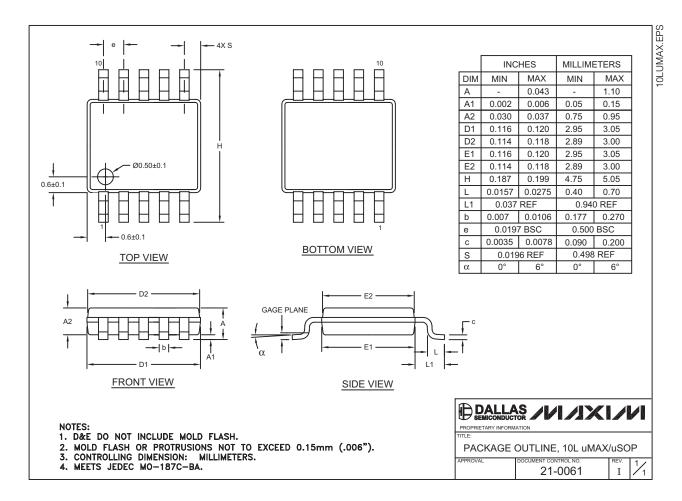
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-DRAWING NOT TO SCALE-

Package Information (continued)

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